Document ID	https://docs.google.com/document/ d/1JEhjaGp8KkxRLIHKm-QlQDed EpljQzpTYs3yLK3NE-A/edit#	
Responsible	Oystein Moldsvor	
Classification	Confidential	



Revision History Table		
Named revision	Date	Comment:
01	2020-06-30	First version shared with UL
02	2020-07-08	Added more detail

8) Internal Photos

Instructions: "Clear sharp focused views of the internals of the device including close up shots of all PCBs (top and bottom, with and without RF shields). It must be possible to identify individual components on PCBs. The photos must be clear and Photos must be taken vertically straight down not angled. All photos are to be placed in a single PDFed exhibit"



Figure 1: Picture of **top** of part 101941 DT-RFIO-Module (US). Only the lids are removed from the two shield boxes to the right. ANT1 and 2 are indicated. ANT2 extends onto the bent part of the board, as indicated in Figure 2.

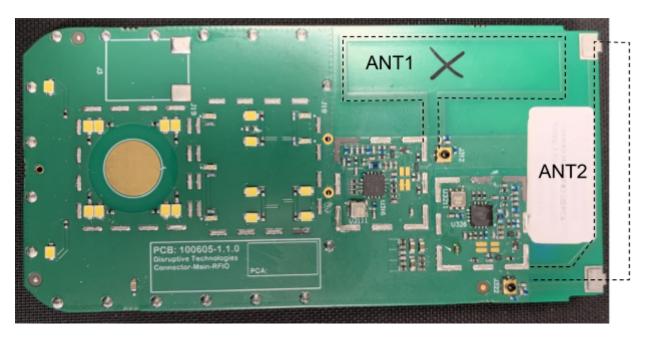


Figure 2: Picture of **top** of part 101941 DT-RFIO-Module (US). All shields are removed. ANT1 and 2 are indicated. ANT2 extends onto the bent part of the board, as indicated by the dotted line.

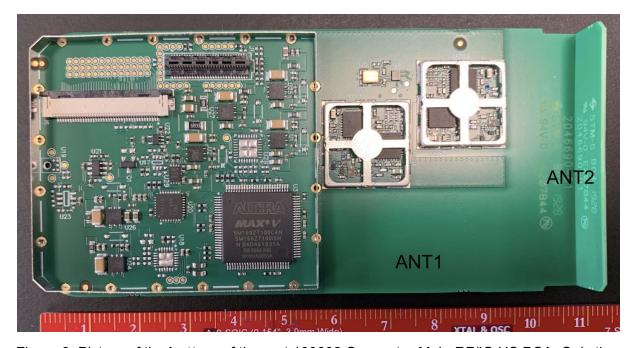


Figure 3: Picture of the **bottom** of the part 100602 Connector-Main-RF/IO US PCA. Only the lids are removed from the two shield boxes. The traces of the antennas go on the other side of the PCB.

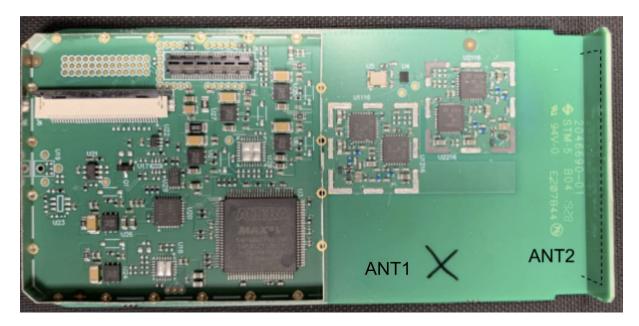


Figure 4: Picture of the **bottom** of the part 100602 Connector-Main-RF/IO US PCA. The shields are completely removed from the shield boxes and the extension of ANT2 onto the bent part of the board is indicated by the dotted line. The traces of the antennas go on the other side of the PCB.